

MEMC Files Resale Registration Statement

Thursday September 25, 5:17 pm ET

ST. PETERS, Mo., Sept. 25 /PRNewswire-FirstCall/ -- MEMC Electronic Materials, Inc. (NYSE: [WFR](#) - [News](#)) today announced that the Company has filed a resale shelf registration statement with the Securities and Exchange Commission. Under the resale registration statement, the selling stockholders may offer and sell up to 40,000,000 currently outstanding shares of the Company's common stock and currently outstanding warrants to purchase up to 10,000,000 shares of the Company's common stock.

The selling stockholders consist of TPG Wafer Holdings LLC and certain other entities in an investor group led by Texas Pacific Group, including funds managed by Leonard Green & Partners, L.P. and TCW/Crescent Mezzanine Management III, LLC (collectively, TPG). This resale registration statement is being filed in accordance with the registration rights agreement MEMC entered into with TPG in November 2001. When available, a prospectus meeting the requirements of Section 10 of the Securities Act may be

obtained from Texas Pacific Group, 301 Commerce Street, Suite 3300, Fort Worth, TX 76102.

The shelf registration statement was filed today with the Securities and Exchange Commission but has not yet become effective. The securities may not be sold nor may offers to buy be accepted prior to the time the registration statement becomes effective. This press release shall not constitute an offer to sell or the solicitation of an offer to buy, nor shall there be any sale of these securities in any state in which such an offer, solicitation or sale would be unlawful prior to registration or qualification under the securities laws of any such state.

MEMC is the world's largest public company solely devoted to the supply of wafers to semiconductor device manufacturers. MEMC has been a pioneer in the design and development of wafer technologies over the past four decades. With R&D and manufacturing facilities in the U.S., Europe and Asia, MEMC enables the next generation of high performance semiconductor devices.